

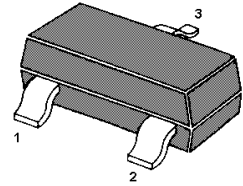
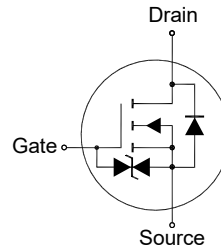
MMFTN3018K

N-Channel Enhancement Mode MOSFET

Features

- Surface-mounted package
- Built-in G-S Protection Diode
- Typical ESD Protection HBM Class 1C

Classification	Voltage Range(V)
0A	< 125
0B	125 to < 250
1A	250 to < 500
1B	500 to < 1000
1C	1000 to < 2000
2	2000 to < 4000
3A	4000 to < 8000
3B	≥ 8000



1. Gate 2. Source 3. Drain
SOT-23 Plastic Package

Application

- Portable appliances
- Battery management

Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

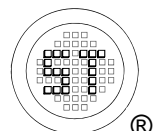
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	100	mA
Peak Drain Current, Pulsed ¹⁾	I_{DM}	400	mA
Total Power Dissipation ²⁾	P_{tot}	350	mW
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient ²⁾	$R_{\theta JA}$	357	$^\circ\text{C/W}$

¹⁾ $P_w \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$.

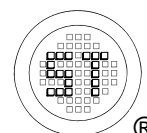
²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



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Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 10\ \mu\text{A}$	$V_{(BR)DSS}$	30	-	-	V
Zero Gate Voltage Drain Current at $V_{DS} = 24\ \text{V}$	I_{DSS}	-	-	1	μA
Gate-source Leakage at $V_{GS} = \pm 20\ \text{V}$	I_{GSS}	-	-	± 1	μA
Gate Source Threshold Voltage at $V_{DS} = 3\ \text{V}$, $I_D = 100\ \mu\text{A}$	$V_{GS(th)}$	0.8	-	1.5	V
Static Drain Source On-State Resistance at $V_{GS} = 4\ \text{V}$, $I_D = 10\ \text{mA}$ at $V_{GS} = 2.5\ \text{V}$, $I_D = 1\ \text{mA}$	$R_{DS(on)}$	- -	- -	8 13	Ω
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS} = 10\ \text{V}$, $I_D = 0.2\ \text{A}$	g_{fs}	-	0.71	-	S
Input Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 25\ \text{V}$, $f = 1\ \text{MHz}$	C_{iss}	-	32	-	pF
Output Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 25\ \text{V}$, $f = 1\ \text{MHz}$	C_{oss}	-	10.2	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 25\ \text{V}$, $f = 1\ \text{MHz}$	C_{rss}	-	7.5	-	pF
Turn-On Delay Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 30\ \text{V}$, $R_G = 25\ \Omega$, $I_D = 0.4\ \text{A}$	$t_{d(on)}$	-	5.4	-	ns
Turn-On Rise Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 30\ \text{V}$, $R_G = 25\ \Omega$, $I_D = 0.4\ \text{A}$	t_r	-	2.7	-	ns
Turn-Off Delay Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 30\ \text{V}$, $R_G = 25\ \Omega$, $I_D = 0.4\ \text{A}$	$t_{d(off)}$	-	5.8	-	ns
Turn-Off Fall Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 30\ \text{V}$, $R_G = 25\ \Omega$, $I_D = 0.4\ \text{A}$	t_f	-	30	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_S = 115\ \text{mA}$	V_{SD}	-	-	1.2	V
Body-Diode Continuous Current	I_S	-	-	100	mA



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

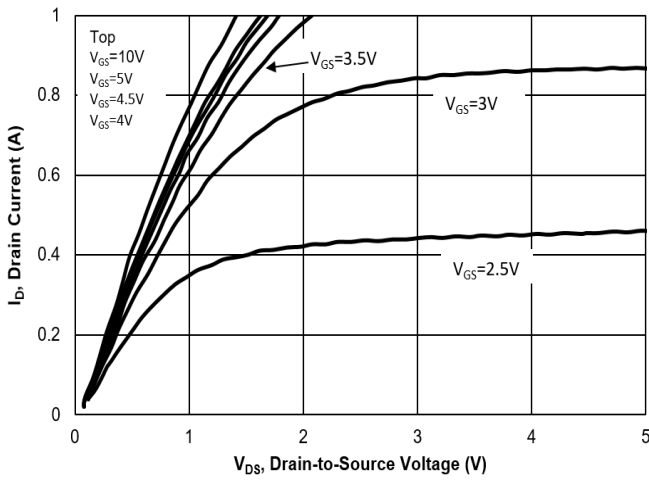


Fig. 2 Typical Transfer Characteristics

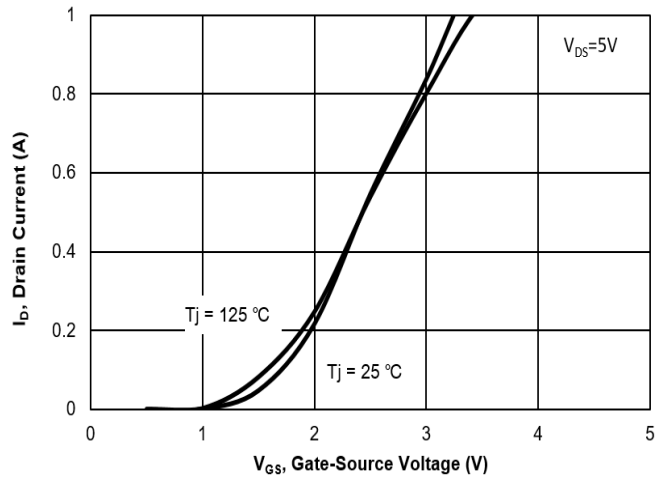


Fig. 3 On-Resistance vs. Drain Current

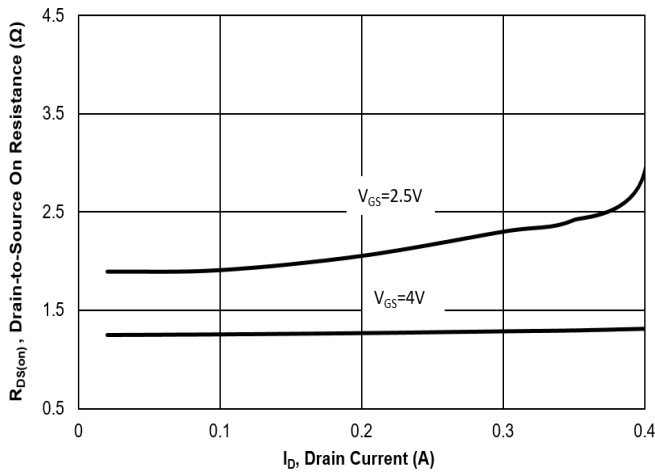


Fig. 4 On-Resistance vs. Gate-Source Voltage

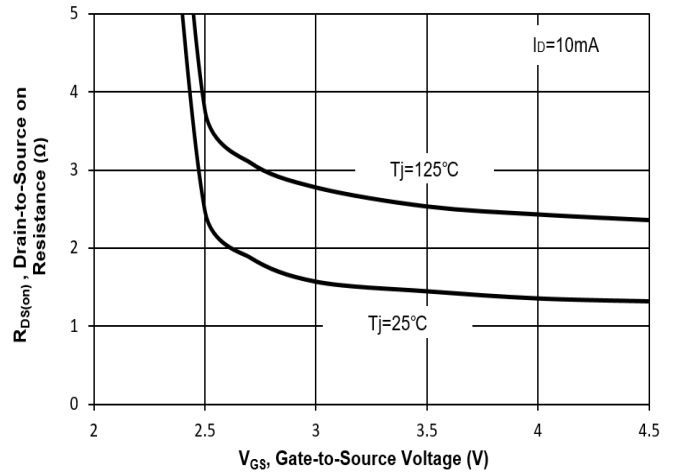


Fig. 5 On-Resistance vs. T_J

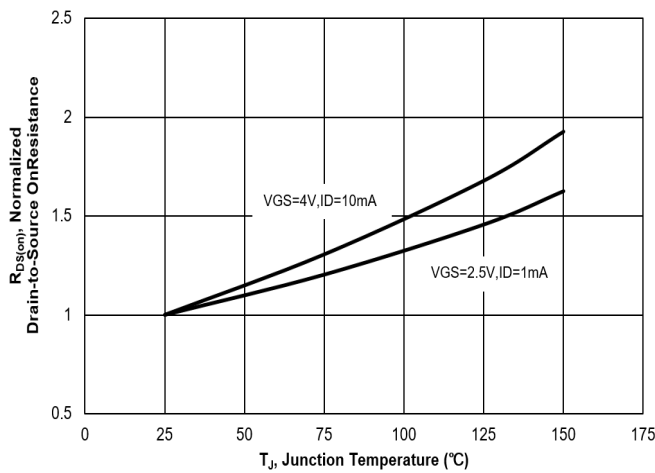
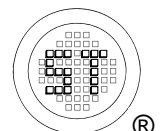
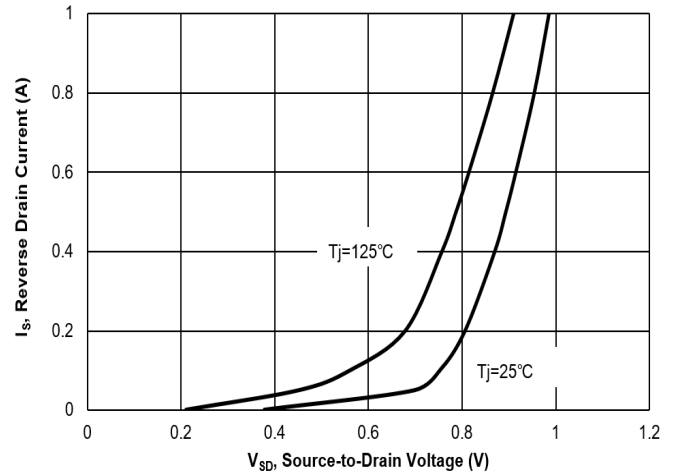


Fig. 6 Typical Body-Diode Forward Characteristics



Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

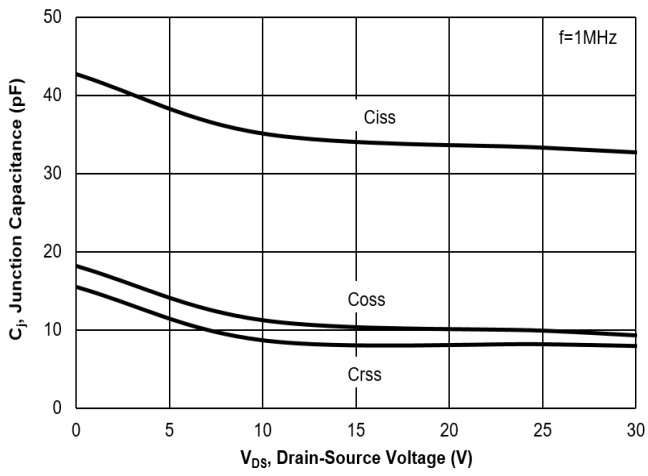


Fig. 8 Gate Threshold Variation vs. T_j

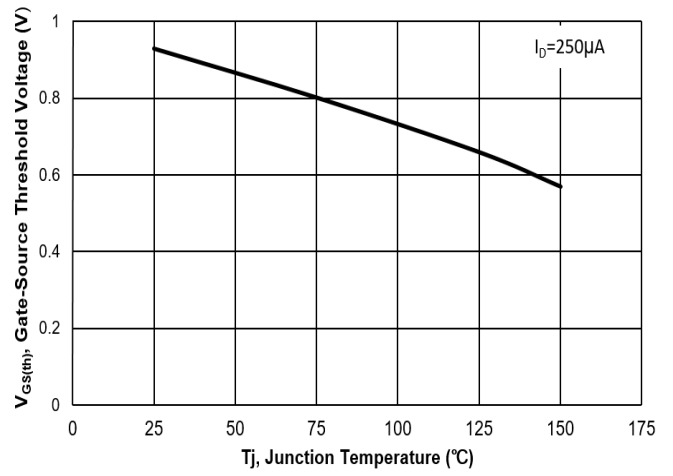
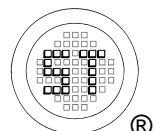
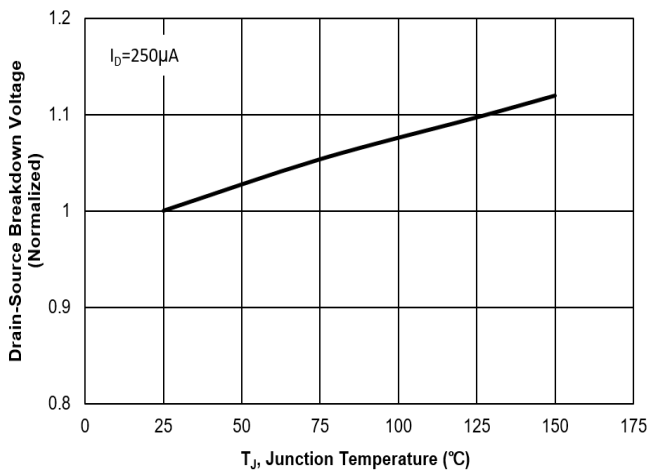


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature



Test Circuits

Fig.1-1 Switching times test circuit

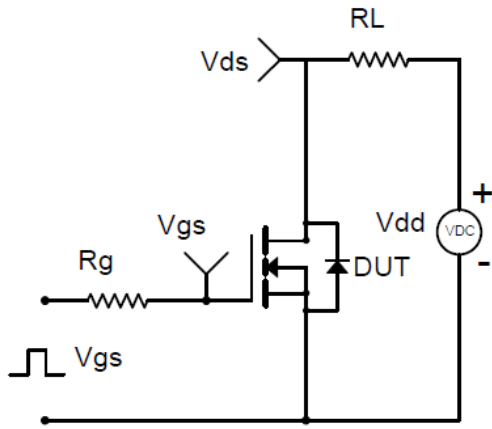


Fig.1-2 Switching Waveform

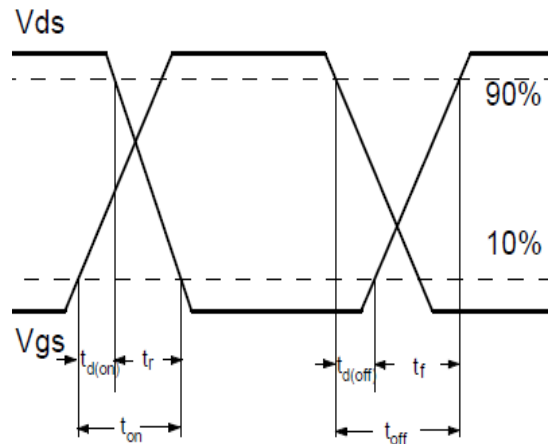


Fig.2-1 Gate charge test circuit

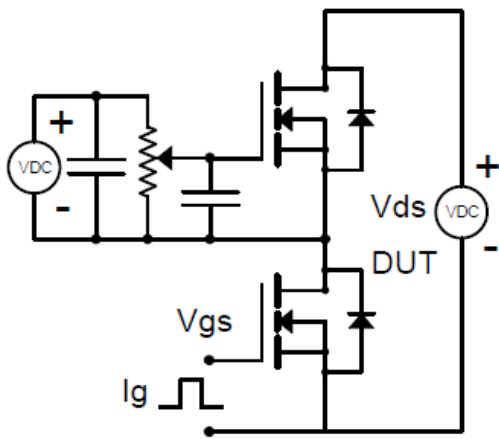
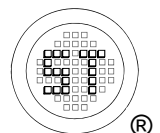
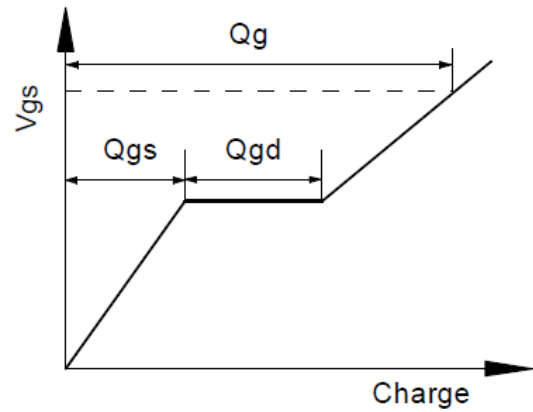


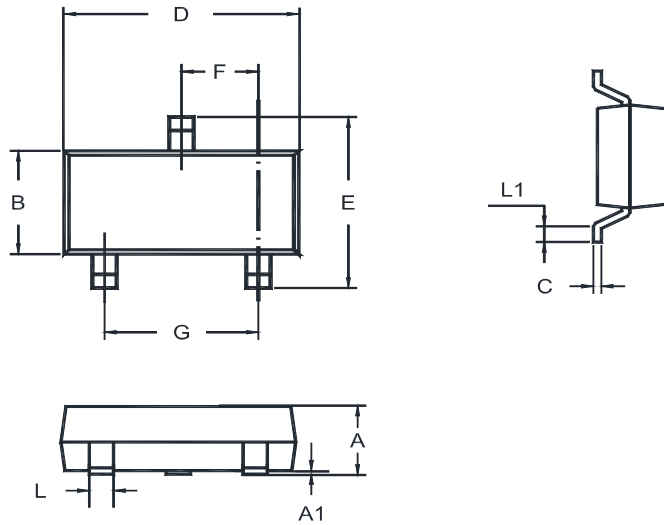
Fig.2-2 Gate charge waveform



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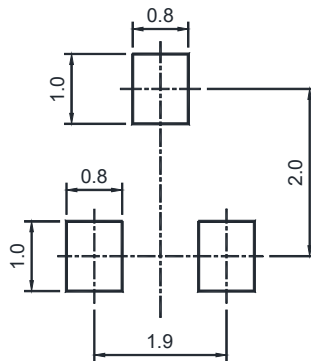
Package Outline (Dimensions in mm)

SOT-23



Unit	A	A1	B	C	D	E	F	G	L	L1
mm	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



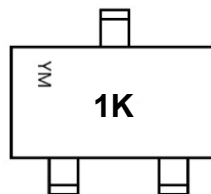
Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

- " 1K " = Part No.
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month

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